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Datasheet of SLSTK2000A - EFM8UB10 UNIVERSAL BEE STARTER K

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# EFM8 Universal Bee Family EFM8UB1 Data Sheet



The EFM8UB1, part of the Universal Bee family of MCUs, is a multi-purpose line of 8-bit microcontrollers with USB feature set in small packages.

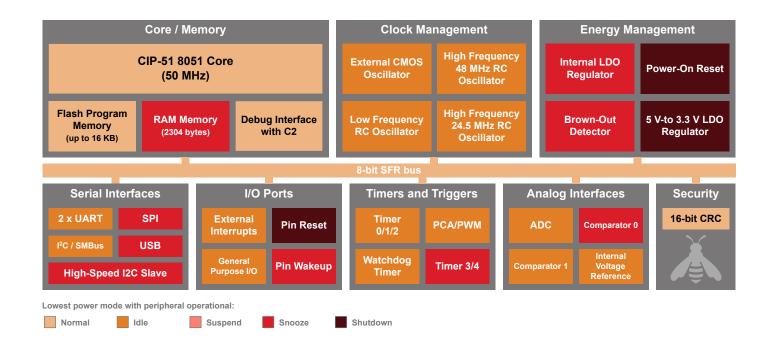
These devices offer high value by integrating an innovative energy-smart USB peripheral interface, charger detect circuit, 8 kV ESD protection, and enhanced high speed communication interfaces into small packages, making them ideal for space-constrained USB applications. With an efficient 8051 core and precision analog, the EFM8UB1 family is also optimal for embedded applications.

EFM8UB1 applications include the following:

- · USB I/O controls, dongles
- · High-speed communication bridge
- · Consumer electronics
- · Medical equipment

#### **KEY FEATURES**

- Pipelined 8-bit C8051 core with 50 MHz maximum operating frequency
- Up to 22 multifunction, 5 V tolerant I/O pins
- Low Energy USB with full- and low-speed support saves up to 90% of the USB energy
- USB charger detect circuit (USB-BCS 1.2 compliant)
- One 12-bit ADC and two analog comparators with internal voltage DAC as reference input
- Five 16-bit timers
- Two UARTs, SPI, SMBus/I2C master/slave and I2C slave
- Priority crossbar for flexible pin mapping





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Feature List

#### 1. Feature List

The EFM8UB1 highlighted features are listed below.

- · Core:
  - · Pipelined CIP-51 Core
  - Fully compatible with standard 8051 instruction set
  - 70% of instructions execute in 1-2 clock cycles
  - 50 MHz maximum operating frequency
- · Memory:
  - Up to 16 KB flash memory, in-system re-programmable from firmware, including 1 KB of 64-byte sectors and 15 KB of 512-byte sectors.
  - Up to 2304 bytes RAM (including 256 bytes standard 8051 RAM, 1024 bytes on-chip XRAM, and 1024 bytes of USB buffer)
- · Power:
  - 5 V-input LDO regulator for direct connection to USB supply
  - · Internal LDO regulator for CPU core voltage
  - · Power-on reset circuit and brownout detectors
- I/O: Up to 22 total multifunction I/O pins:
  - · All pins 5 V tolerant under bias
  - · Flexible peripheral crossbar for peripheral routing
  - · 5 mA source, 12.5 mA sink allows direct drive of LEDs
- Clock Sources:
  - Internal 48 MHz oscillator with accuracy of ±1.5% standalone and ±0.25% using USB clock recovery
  - Internal 24.5 MHz oscillator with ±2% accuracy
  - · Internal 80 kHz low-frequency oscillator
  - External CMOS clock option

- · Timers/Counters and PWM:
  - 3-channel Programmable Counter Array (PCA) supporting PWM, capture/compare, and frequency output modes
  - 5 x 16-bit general-purpose timers
  - Independent watchdog timer, clocked from the low frequency oscillator
- · Communications and Digital Peripherals:
  - USB 2.0-compliant full speed with integrated low-power transceiver, 4 bidirectional endpoints, and dedicated 1 KB buffer
  - · 2 x UART, up to 3 Mbaud
  - SPI™ Master / Slave, up to 12 Mbps
  - SMBus™/I2C™ Master / Slave, up to 400 kbps
  - I<sup>2</sup>C High-Speed Slave, up to 3.4 Mbps
  - 16-bit CRC unit, supporting automatic CRC of flash at 256byte boundaries
- · Analog:
  - 12-Bit Analog-to-Digital Converter (ADC)
  - 2 x Low-current analog comparators with adjustable reference
- · On-Chip, Non-Intrusive Debugging
  - · Full memory and register inspection
  - · Four hardware breakpoints, single-stepping
- · Pre-loaded USB bootloader
- Temperature range -40 to 85 °C
- Single power supply of 2.2 to 3.6 V or 3.0 to 5.25 V
- QSOP24, QFN28, and QFN20 packages

With on-chip power-on reset, voltage supply monitor, watchdog timer, and clock oscillator, the EFM8UB1 devices are truly standalone system-on-a-chip solutions. The flash memory is reprogrammable in-circuit, providing nonvolatile data storage and allowing field upgrades of the firmware. The on-chip debugging interface (C2) allows non-intrusive (uses no on-chip resources), full speed, in-circuit debugging using the production MCU installed in the final application. This debug logic supports inspection and modification of memory and registers, setting breakpoints, single stepping, and run and halt commands. All analog and digital peripherals are fully functional while debugging. The on-chip 5V-to-3.3V regulator enables operation from 2.2 V up to a 5.25 V supply. Devices are available in 28-pin QFN, 20-pin QFN, or 24-pin QSOP packages. All package options are lead-free and RoHS compliant.

# 2. Ordering Information

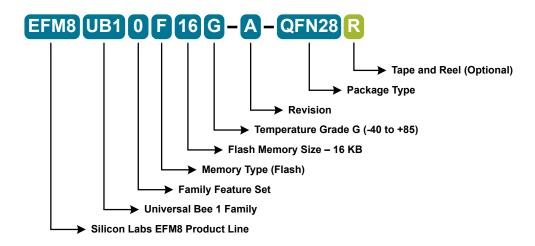


Figure 2.1. EFM8UB1 Part Numbering

All EFM8UB1 family members have the following features:

- · CIP-51 Core running up to 50 MHz
- Three Internal Oscillators (48 MHz, 24.5 MHz and 80 kHz)
- · USB Full/Low speed Function Controller
- SMBus
- I2C Slave
- SPI
- 2 UARTs
- 3-Channel Programmable Counter Array (PWM, Clock Generation, Capture/Compare)
- 5 16-bit Timers
- · 2 Analog Comparators
- 12-bit Analog-to-Digital Converter with integrated multiplexer, voltage reference, and temperature sensor
- · 16-bit CRC Unit
- · Pre-loaded USB bootloader

In addition to these features, each part number in the EFM8UB1 family has a set of features that vary across the product line. The product selection guide shows the features available on each family member.

Table 2.1. Product Selection Guide

Ordering Part Number	Flash Memory (kB)	RAM (Bytes)	Digital Port I/Os (Total)	ADC0 Channels	Comparator 0 Inputs	Comparator 1 Inputs	Pb-free (RoHS Compliant)	Separate VIO and VDD Pins	Temperature Range	Package
EFM8UB10F16G-C-QFN28	16	2304	22	20	10	12	Yes	_	-40 to +85 °C	QFN28
EFM8UB11F16G-C-QSOP24	16	2304	17	15	8	9	Yes	Yes	-40 to +85 °C	QSOP24
EFM8UB10F16G-C-QFN20	16	2304	13	11	8	5	Yes	_	-40 to +85 °C	QFN20
EFM8UB10F8G-C-QFN20	8	2304	13	11	8	5	Yes	_	-40 to +85 °C	QFN20

# 3. System Overview

#### 3.1 Introduction

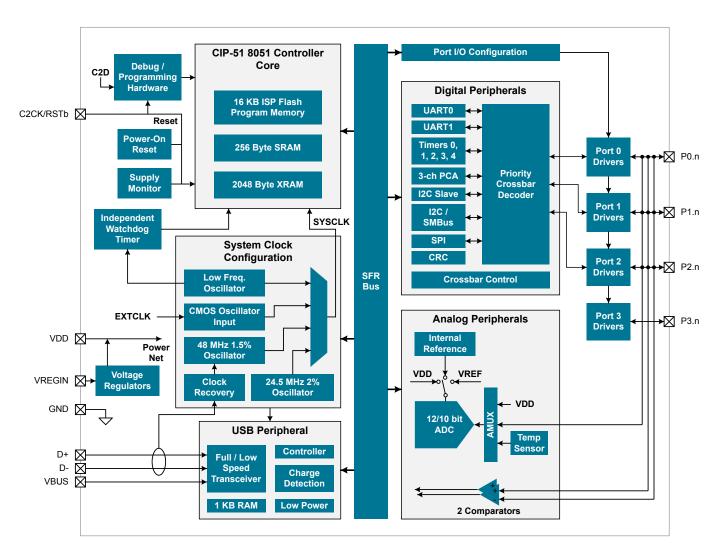


Figure 3.1. Detailed EFM8UB1 Block Diagram



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System Overview

#### 3.2 Power

All internal circuitry draws power from the VDD supply pin. External I/O pins are powered from the VIO supply voltage (or VDD on devices without a separate VIO connection), while most of the internal circuitry is supplied by an on-chip LDO regulator. Control over the device power can be achieved by enabling/disabling individual peripherals as needed. Each analog peripheral can be disabled when not in use and placed in low power mode. Digital peripherals, such as timers and serial buses, have their clocks gated off and draw little power when they are not in use.

Table 3.1. Power Modes

Power Mode	Details	Mode Entry	Wake-Up Sources
Normal	Core and all peripherals clocked and fully operational	_	_
Idle	<ul> <li>Core halted</li> <li>All peripherals clocked and fully operational</li> <li>Code resumes execution on wake event</li> </ul>	Set IDLE bit in PCON0	Any interrupt
Suspend	<ul> <li>Core and peripheral clocks halted</li> <li>HFOSC0 and HFOSC1 oscillators stopped</li> <li>Regulators in normal bias mode for fast wake</li> <li>Timer 3 and 4 may clock from LFOSC0</li> <li>Code resumes execution on wake event</li> </ul>	1. Switch SYSCLK to HFOSC0 2. Set SUSPEND bit in PCON1	<ul> <li>USB0 Bus Activity</li> <li>Timer 4 Event</li> <li>SPI0 Activity</li> <li>I2C0 Slave Activity</li> <li>Port Match Event</li> <li>Comparator 0 Falling Edge</li> </ul>
Stop	<ul> <li>All internal power nets shut down</li> <li>5V regulator remains active (if enabled)</li> <li>Internal 1.8 V LDO on</li> <li>Pins retain state</li> <li>Exit on any reset source</li> </ul>	1. Clear STOPCF bit in REG0CN 2. Set STOP bit in PCON0	Any reset source
Snooze	<ul> <li>Core and peripheral clocks halted</li> <li>HFOSC0 and HFOSC1 oscillators stopped</li> <li>Regulators in low bias current mode for energy savings</li> <li>Timer 3 and 4 may clock from LFOSC0</li> <li>Code resumes execution on wake event</li> </ul>	1. Switch SYSCLK to HFOSC0 2. Set SNOOZE bit in PCON1	<ul> <li>USB0 Bus Activity</li> <li>Timer 4 Event</li> <li>SPI0 Activity</li> <li>I2C0 Slave Activity</li> <li>Port Match Event</li> <li>Comparator 0 Falling Edge</li> </ul>
Shutdown	<ul> <li>All internal power nets shut down</li> <li>5V regulator remains active (if enabled)</li> <li>Internal 1.8 V LDO off to save energy</li> <li>Pins retain state</li> <li>Exit on pin or power-on reset</li> </ul>	1. Set STOPCF bit in REG0CN 2. Set STOP bit in PCON0	RSTb pin reset     Power-on reset

#### 3.3 I/O

Digital and analog resources are externally available on the device's multi-purpose I/O pins. Port pins P0.0-P2.3 can be defined as general-purpose I/O (GPIO), assigned to one of the internal digital resources through the crossbar or dedicated channels, or assigned to an analog function. Port pins P3.0 and P3.1 can be used as GPIO. Additionally, the C2 Interface Data signal (C2D) is shared with P3.0.

The port control block offers the following features:

- Up to 22 multi-functions I/O pins, supporting digital and analog functions.
- · Flexible priority crossbar decoder for digital peripheral assignment.
- · Two drive strength settings for each port.
- Two direct-pin interrupt sources with dedicated interrupt vectors (INT0 and INT1).
- Up to 20 direct-pin interrupt sources with shared interrupt vector (Port Match).



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#### 3.4 Clocking

The CPU core and peripheral subsystem may be clocked by both internal and external oscillator resources. By default, the system clock comes up running from the 24.5 MHz oscillator divided by 8.

The clock control system offers the following features:

- · Provides clock to core and peripherals.
- 24.5 MHz internal oscillator (HFOSC0), accurate to ±2% over supply and temperature corners.
- 48 MHz internal oscillator (HFOSC1), accurate to ±1.5% over supply and temperature corners.
- 80 kHz low-frequency oscillator (LFOSC0).
- · External CMOS clock input (EXTCLK).
- · Clock divider with eight settings for flexible clock scaling:
  - Divide the selected clock source by 1, 2, 4, 8, 16, 32, 64, or 128.
  - · HFOSC0 and HFOSC1 include 1.5x pre-scalers for further flexibility.

#### 3.5 Counters/Timers and PWM

#### **Programmable Counter Array (PCA0)**

The programmable counter array (PCA) provides multiple channels of enhanced timer and PWM functionality while requiring less CPU intervention than standard counter/timers. The PCA consists of a dedicated 16-bit counter/timer and one 16-bit capture/compare module for each channel. The counter/timer is driven by a programmable timebase that has flexible external and internal clocking options. Each capture/compare module may be configured to operate independently in one of five modes: Edge-Triggered Capture, Software Timer, High-Speed Output, Frequency Output, or Pulse-Width Modulated (PWM) Output. Each capture/compare module has its own associated I/O line (CEXn) which is routed through the crossbar to port I/O when enabled.

- · 16-bit time base
- · Programmable clock divisor and clock source selection
- · Up to three independently-configurable channels
- 8, 9, 10, 11 and 16-bit PWM modes (center or edge-aligned operation)
- · Output polarity control
- · Frequency output mode
- · Capture on rising, falling or any edge
- Compare function for arbitrary waveform generation
- · Software timer (internal compare) mode
- · Can accept hardware "kill" signal from comparator 0



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#### Timers (Timer 0, Timer 1, Timer 2, Timer 3, and Timer 4)

Several counter/timers are included in the device: two are 16-bit counter/timers compatible with those found in the standard 8051, and the rest are 16-bit auto-reload timers for timing peripherals or for general purpose use. These timers can be used to measure time intervals, count external events and generate periodic interrupt requests. Timer 0 and Timer 1 are nearly identical and have four primary modes of operation. The other timers offer both 16-bit and split 8-bit timer functionality with auto-reload and capture capabilities.

Timer 0 and Timer 1 include the following features:

- · Standard 8051 timers, supporting backwards-compatibility with firmware and hardware.
- Clock sources include SYSCLK, SYSCLK divided by 12, 4, or 48, the External Clock divided by 8, or an external pin.
- · 8-bit auto-reload counter/timer mode
- · 13-bit counter/timer mode
- · 16-bit counter/timer mode
- · Dual 8-bit counter/timer mode (Timer 0)

Timer 2, Timer 3 and Timer 4 are 16-bit timers including the following features:

- Clock sources for all timers include SYSCLK, SYSCLK divided by 12, or the External Clock divided by 8.
- · LFOSC0 divided by 8 may be used to clock Timer 3 and Timer 4 in active or suspend/snooze power modes.
- Timer 4 is a low-power wake source, and can be chained together with Timer 3.
- 16-bit auto-reload timer mode.
- · Dual 8-bit auto-reload timer mode.
- · External pin capture.
- · LFOSC0 capture.
- · Comparator 0 capture.
- · USB Start-of-Frame (SOF) capture.

#### Watchdog Timer (WDT0)

The device includes a programmable watchdog timer (WDT) running off the low-frequency oscillator. A WDT overflow forces the MCU into the reset state. To prevent the reset, the WDT must be restarted by application software before overflow. If the system experiences a software or hardware malfunction preventing the software from restarting the WDT, the WDT overflows and causes a reset. Following a reset, the WDT is automatically enabled and running with the default maximum time interval. If needed, the WDT can be disabled by system software or locked on to prevent accidental disabling. Once locked, the WDT cannot be disabled until the next system reset. The state of the RST pin is unaffected by this reset.

The Watchdog Timer has the following features:

- · Programmable timeout interval
- · Runs from the low-frequency oscillator
- · Lock-out feature to prevent any modification until a system reset

#### 3.6 Communications and Other Digital Peripherals

## Universal Serial Bus (USB0)

The USB0 peripheral provides a full-speed USB 2.0 compliant device controller and PHY with additional Low Energy USB features. The device supports both full-speed (12MBit/s) and low speed (1.5MBit/s) operation, and includes a dedicated USB oscillator with clock recovery mechanism for crystal-free operation. No external components are required. The USB function controller (USB0) consists of a Serial Interface Engine (SIE), USB transceiver (including matching resistors and configurable pull-up resistors), and 1 KB FIFO block. The Low Energy Mode ensures the current consumption is optimized and enables USB communication on a strict power budget.

The USB0 module includes the following features:

- · Full and Low Speed functionality.
- · Implements 4 bidirectional endpoints.
- · Low Energy Mode to reduce active supply current based on bus bandwidth.
- USB 2.0 compliant USB peripheral support (no host capability).
- · Direct module access to 1 KB of RAM for FIFO memory.
- · Clock recovery to meet USB clocking requirements with no external components.
- · Charger detection circuitry with automatic detection of SDP, CDP, and DCP interfaces.
- D+ and D- can be routed to ADC input to support ACM and proprietary charger architectures.



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System Overview

#### Universal Asynchronous Receiver/Transmitter (UART0)

UART0 is an asynchronous, full duplex serial port offering modes 1 and 3 of the standard 8051 UART. Enhanced baud rate support allows a wide range of clock sources to generate standard baud rates. Received data buffering allows UART0 to start reception of a second incoming data byte before software has finished reading the previous data byte.

The UART module provides the following features:

- · Asynchronous transmissions and receptions
- · Baud rates up to SYSCLK/2 (transmit) or SYSCLK/8 (receive)
- 8- or 9-bit data
- · Automatic start and stop generation
- · Single-byte buffer on transmit and receive

#### Universal Asynchronous Receiver/Transmitter (UART1)

UART1 is an asynchronous, full duplex serial port offering a variety of data formatting options. A dedicated baud rate generator with a 16-bit timer and selectable prescaler is included, which can generate a wide range of baud rates. A received data FIFO allows UART1 to receive multiple bytes before data is lost and an overflow occurs.

UART1 provides the following features:

- · Asynchronous transmissions and receptions.
- · Dedicated baud rate generator supports baud rates up to SYSCLK/2 (transmit) or SYSCLK/8 (receive).
- 5, 6, 7, 8, or 9 bit data.
- · Automatic start and stop generation.
- · Automatic parity generation and checking.
- · Four byte FIFO on transmit and receive.
- · Auto-baud detection.
- · LIN break and sync field detection.
- · CTS / RTS hardware flow control.

#### Serial Peripheral Interface (SPI0)

The serial peripheral interface (SPI) module provides access to a flexible, full-duplex synchronous serial bus. The SPI can operate as a master or slave device in both 3-wire or 4-wire modes, and supports multiple masters and slaves on a single SPI bus. The slave-select (NSS) signal can be configured as an input to select the SPI in slave mode, or to disable master mode operation in a multi-master environment, avoiding contention on the SPI bus when more than one master attempts simultaneous data transfers. NSS can also be configured as a firmware-controlled chip-select output in master mode, or disabled to reduce the number of pins required. Additional general purpose port I/O pins can be used to select multiple slave devices in master mode.

- · Supports 3- or 4-wire master or slave modes.
- Supports external clock frequencies up to 12 Mbps in master or slave mode.
- · Support for all clock phase and polarity modes.
- · 8-bit programmable clock rate (master).
- · Programmable receive timeout (slave).
- · Four byte FIFO on transmit and receive.
- · Can operate in suspend or snooze modes and wake the CPU on reception of a byte.
- · Support for multiple masters on the same data lines.



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#### System Management Bus / I2C (SMB0)

The SMBus I/O interface is a two-wire, bi-directional serial bus. The SMBus is compliant with the System Management Bus Specification, version 1.1, and compatible with the I<sup>2</sup>C serial bus.

The SMBus module includes the following features:

- Standard (up to 100 kbps) and Fast (400 kbps) transfer speeds
- · Support for master, slave, and multi-master modes
- · Hardware synchronization and arbitration for multi-master mode
- · Clock low extending (clock stretching) to interface with faster masters
- · Hardware support for 7-bit slave and general call address recognition
- · Firmware support for 10-bit slave address decoding
- · Ability to inhibit all slave states
- · Programmable data setup/hold times
- · Transmit and receive buffers to help increase throughput in faster applications

#### I2C Slave (I2CSLAVE0)

The I2C Slave interface is a 2-wire, bidirectional serial bus that is compatible with the I2C Bus Specification 3.0. It is capable of transferring in high-speed mode (HS-mode) at speeds of up to 3.4 Mbps. Firmware can write to the I2C interface, and the I2C interface can autonomously control the serial transfer of data. The interface also supports clock stretching for cases where the core may be temporarily prohibited from transmitting a byte or processing a received byte during an I2C transaction. This module operates only as an I2C slave device.

The I2C module includes the following features:

- Standard (up to 100 kbps), Fast (400 kbps), Fast Plus (1 Mbps), and High-speed (3.4 Mbps) transfer speeds
- · Support for slave mode only
- · Clock low extending (clock stretching) to interface with faster masters
- · Hardware support for 7-bit slave address recognition

## 16-bit CRC (CRC0)

The cyclic redundancy check (CRC) module performs a CRC using a 16-bit polynomial. CRC0 accepts a stream of 8-bit data and posts the 16-bit result to an internal register. In addition to using the CRC block for data manipulation, hardware can automatically CRC the flash contents of the device.

The CRC module is designed to provide hardware calculations for flash memory verification and communications protocols. The CRC module supports the standard CCITT-16 16-bit polynomial (0x1021), and includes the following features:

- · Support for CCITT-16 polynomial
- · Byte-level bit reversal
- · Automatic CRC of flash contents on one or more 256-byte blocks
- Initial seed selection of 0x0000 or 0xFFFF



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#### 3.7 Analog

#### 12-Bit Analog-to-Digital Converter (ADC0)

The ADC is a successive-approximation-register (SAR) ADC with 12-, 10-, and 8-bit modes, integrated track-and hold and a program-mable window detector. The ADC is fully configurable under software control via several registers. The ADC may be configured to measure different signals using the analog multiplexer. The voltage reference for the ADC is selectable between internal and external reference sources.

- · Up to 20 external inputs.
- · Single-ended 12-bit and 10-bit modes.
- Supports an output update rate of 200 ksps samples per second in 12-bit mode or 800 ksps samples per second in 10-bit mode.
- Operation in low power modes at lower conversion speeds.
- Asynchronous hardware conversion trigger, selectable between software, external I/O and internal timer sources.
- · Output data window comparator allows automatic range checking.
- Support for burst mode, which produces one set of accumulated data per conversion-start trigger with programmable power-on settling and tracking time.
- · Conversion complete and window compare interrupts supported.
- · Flexible output data formatting.
- · Includes an internal fast-settling reference with two levels (1.65 V and 2.4 V) and support for external reference and signal ground.
- · Integrated temperature sensor.

#### Low Current Comparators (CMP0, CMP1)

Analog comparators are used to compare the voltage of two analog inputs, with a digital output indicating which input voltage is higher. External input connections to device I/O pins and internal connections are available through separate multiplexers on the positive and negative inputs. Hysteresis, response time, and current consumption may be programmed to suit the specific needs of the application.

The comparator includes the following features:

- Up to 10 (CMP0) or 12 (CMP1) external positive inputs
- Up to 10 (CMP0) or 12 (CMP1) external negative inputs
- Additional input options:
  - · Internal connection to LDO output
  - · Direct connection to GND
  - · Direct connection to VDD
  - · Dedicated 6-bit reference DAC
- · Synchronous and asynchronous outputs can be routed to pins via crossbar
- Programmable hysteresis between 0 and ±20 mV
- · Programmable response time
- · Interrupts generated on rising, falling, or both edges
- · PWM output kill feature



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System Overview

#### 3.8 Reset Sources

Reset circuitry allows the controller to be easily placed in a predefined default condition. On entry to this reset state, the following occur:

- · The core halts program execution.
- · Module registers are initialized to their defined reset values unless the bits reset only with a power-on reset.
- · External port pins are forced to a known state.
- · Interrupts and timers are disabled.

All registers are reset to the predefined values noted in the register descriptions unless the bits only reset with a power-on reset. The contents of RAM are unaffected during a reset; any previously stored data is preserved as long as power is not lost. The Port I/O latches are reset to 1 in open-drain mode. Weak pullups are enabled during and after the reset. For Supply Monitor and power-on resets, the RSTb pin is driven low until the device exits the reset state. On exit from the reset state, the program counter (PC) is reset, and the system clock defaults to an internal oscillator. The Watchdog Timer is enabled, and program execution begins at location 0x0000.

Reset sources on the device include:

- · Power-on reset
- · External reset pin
- · Comparator reset
- Software-triggered reset
- · Supply monitor reset (monitors VDD supply)
- · Watchdog timer reset
- · Missing clock detector reset
- · Flash error reset
- USB reset

#### 3.9 Debugging

The EFM8UB1 devices include an on-chip Silicon Labs 2-Wire (C2) debug interface to allow flash programming and in-system debugging with the production part installed in the end application. The C2 interface uses a clock signal (C2CK) and a bi-directional C2 data signal (C2D) to transfer information between the device and a host system. See the C2 Interface Specification for details on the C2 protocol.

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#### 3.10 Bootloader

All devices come pre-programmed with a USB bootloader. This bootloader resides in the code security page and last pages of code flash; it can be erased if it is not needed.

The byte before the Lock Byte is the Bootloader Signature Byte. Setting this byte to a value of 0xA5 indicates the presence of the bootloader in the system. Any other value in this location indicates that the bootloader is not present in flash.

When a bootloader is present, the device will jump to the bootloader vector after any reset, allowing the bootloader to run. The bootloader then determines if the device should stay in bootload mode or jump to the reset vector located at 0x0000. When the bootloader is not present, the device will jump to the reset vector of 0x0000 after any reset.

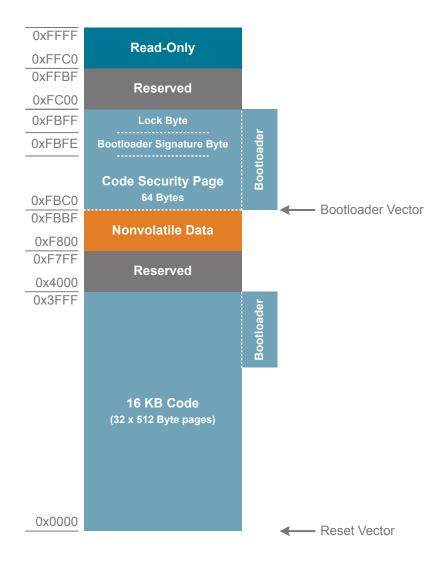


Figure 3.2. Flash Memory Map with Bootloader—16 KB Devices



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Electrical Specifications

## 4. Electrical Specifications

#### 4.1 Electrical Characteristics

All electrical parameters in all tables are specified under the conditions listed in Table 4.1 Recommended Operating Conditions on page 12, unless stated otherwise.

#### 4.1.1 Recommended Operating Conditions

**Table 4.1. Recommended Operating Conditions** 

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Operating Supply Voltage on VDD	V <sub>DD</sub>		2.2	_	3.6	V
Operating Supply Voltage on VIO <sup>3</sup>	V <sub>IO</sub>		1.71	_	$V_{DD}$	V
Operating Supply Voltage on VRE- GIN	V <sub>REGIN</sub>		3.0	_	5.25	V
System Clock Frequency	f <sub>SYSCLK</sub>		0	_	50	MHz
Operating Ambient Temperature	T <sub>A</sub>		-40	_	85	°C

#### Note:

- 1. Standard USB compliance tests require 3.0 V on VDD for compliant operation.
- 2. All voltages with respect to GND.
- 3. On devices without a VIO pin,  $V_{IO} = V_{DD}$ .
- 4. GPIO levels are undefined whenever VIO is less than 1 V.

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Electrical Specifications

## 4.1.2 Power Consumption

#### **Table 4.2. Power Consumption**

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Digital Core Supply Current						
Normal Mode-Full speed with code	I <sub>DD</sub>	F <sub>SYSCLK</sub> = 48 MHz <sup>2</sup>	_	8.9	9.8	mA
executing from flash		F <sub>SYSCLK</sub> = 24.5 MHz <sup>2</sup>	_	4.3	4.9	mA
		F <sub>SYSCLK</sub> = 1.53 MHz <sup>2</sup>	_	600	_	μА
		F <sub>SYSCLK</sub> = 80 kHz <sup>3</sup>	_	145	9.8	μΑ
Idle Mode-Core halted with peripherals running	I <sub>DD</sub>	F <sub>SYSCLK</sub> = 48 MHz <sup>2</sup>	_	6	6.6	mA
		F <sub>SYSCLK</sub> = 24.5 MHz <sup>2</sup>	_	2.8	3.2	mA
		F <sub>SYSCLK</sub> = 1.53 MHz <sup>2</sup>	_	440	_	μА
		F <sub>SYSCLK</sub> = 80 kHz <sup>3</sup>	_	130	_	μА
Suspend Mode-Core halted and	I <sub>DD</sub>	LFO Running	_	125	_	μA
gh frequency clocks stopped, upply monitor off.		LFO Stopped	_	120	_	μА
Snooze Mode-Core halted and	I <sub>DD</sub>	LFO Running	_	25	_	μA
high frequency clocks stopped. Regulator in low-power state, Supply monitor off.		LFO Stopped	_	8.9 4.3 600 145 6 2.8 440 130 125 120	_	μΑ
Stop Mode—Core halted and all clocks stopped,Internal LDO On, Supply monitor off.	I <sub>DD</sub>		_	120	_	μА
Shutdown Mode—Core halted and all clocks stopped,Internal LDO Off, Supply monitor off.	I <sub>DD</sub>		_	0.2	_	μА
Analog Peripheral Supply Currents	1		1	l	I	
High-Frequency Oscillator 0	I <sub>HFOSC0</sub>	Operating at 24.5 MHz,	_	105	_	μA
		T <sub>A</sub> = 25 °C				
High-Frequency Oscillator 1	I <sub>HFOSC1</sub>	Operating at 48 MHz,	_	850	_	μΑ
		T <sub>A</sub> = 25 °C				
Low-Frequency Oscillator	I <sub>LFOSC</sub>	Operating at 80 kHz,	_	4	_	μА
		T <sub>A</sub> = 25 °C				



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Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
ADC0 Always-on <sup>4</sup>	I <sub>ADC</sub>	800 ksps, 10-bit conversions or	_	820	1200	μA
		200 ksps, 12-bit conversions				
		Normal bias settings				
		V <sub>DD</sub> = 3.0 V				
		250 ksps, 10-bit conversions or	_	405	580	μA
		62.5 ksps 12-bit conversions				
		Low power bias settings				
		V <sub>DD</sub> = 3.0 V				
ADC0 Burst Mode, 10-bit single	I <sub>ADC</sub>	200 ksps, V <sub>DD</sub> = 3.0 V	_	370	_	μA
onversions, external reference		100 ksps, V <sub>DD</sub> = 3.0 V	_	185	_	μA
		10 ksps, V <sub>DD</sub> = 3.0 V	_	20	_	μA
ADC0 Burst Mode, 10-bit single	I <sub>ADC</sub>	200 ksps, V <sub>DD</sub> = 3.0 V	_	485	_	μA
conversions, internal reference, Low power bias settings		100 ksps, V <sub>DD</sub> = 3.0 V	_	245	_	μA
		10 ksps, V <sub>DD</sub> = 3.0 V	_	25	_	μA
ADC0 Burst Mode, 12-bit single	I <sub>ADC</sub>	100 ksps, V <sub>DD</sub> = 3.0 V	_	505	_	μA
conversions, external reference		50 ksps, V <sub>DD</sub> = 3.0 V	_	255	_	μA
		10 ksps, V <sub>DD</sub> = 3.0 V	_	50 —	μA	
ADC0 Burst Mode, 12-bit single	I <sub>ADC</sub>	100 ksps, V <sub>DD</sub> = 3.0 V,	_	950	_	μA
conversions, internal reference		Normal bias				
		50 ksps, V <sub>DD</sub> = 3.0 V,	_	415	_	μA
		Low power bias				
		10 ksps, V <sub>DD</sub> = 3.0 V,	_	80	_	μA
		Low power bias				
Internal ADC0 Reference, Always-	I <sub>VREFFS</sub>	Normal Power Mode	_	680	790	μA
on <sup>5</sup>		Low Power Mode	_	170	210	μA
Temperature Sensor	I <sub>TSENSE</sub>		_	70	120	μA
Comparator 0 (CMP0, CMP1)	I <sub>CMP</sub>	CPMD = 11	_	0.5	_	μA
		CPMD = 10	_	3	_	μA
		CPMD = 01	_	8.5	_	μA
		CPMD = 00	_	22.5	_	μA
Comparator Reference	I <sub>CPREF</sub>		_	1.2	_	μA
Voltage Supply Monitor (VMON0)	I <sub>VMON</sub>		_	15	20	μA



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Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
5V Regulator	I <sub>VREG</sub>	Normal Mode	_	245	340	μA
		(SUSEN = 0, BIASENB = 0)				
		Suspend Mode	_	60	100	μA
		(SUSEN = 1, BIASENB = 0)				
		Bias Disabled	_	2.5	10	μA
		(BIASENB = 1)				
		Disabled	_	2.5	_	nA
		(BIASENB = 1, REG1ENB = 1)				
USB (USB0) Full-Speed	I <sub>USB</sub>	Low Energy Mode, 64 byte 1ms IN Interrupt transfers	_	850	_	μА
		Low Energy Mode, 64 byte 1ms OUT Interrupt transfers	_	250	_	μА
		Low Energy Mode, Idle (SOF only)	_	50	_	μΑ

#### Note:

- 1. Currents are additive. For example, where I<sub>DD</sub> is specified and the mode is not mutually exclusive, enabling the functions increases supply current by the specified amount.
- 2. Includes supply current from internal LDO regulator, supply monitor, and High Frequency Oscillator.
- 3. Includes supply current from internal LDO regulator, supply monitor, and Low Frequency Oscillator.
- 4. ADC0 always-on power excludes internal reference supply current.
- 5. The internal reference is enabled as-needed when operating the ADC in burst mode to save power.

## 4.1.3 Reset and Supply Monitor

Table 4.3. Reset and Supply Monitor

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
VDD Supply Monitor Threshold	$V_{VDDM}$		1.95	2.05	2.15	V
Power-On Reset (POR) Threshold	V <sub>POR</sub>	Rising Voltage on VDD	_	1.2	_	V
		Falling Voltage on VDD	0.75	_	1.36	V
VDD Ramp Time	t <sub>RMP</sub>	Time to V <sub>DD</sub> > 2.2 V	10	_	_	μs
Reset Delay from POR	t <sub>POR</sub>	Relative to V <sub>DD</sub> > V <sub>POR</sub>	3	10	31	ms
Reset Delay from non-POR source	t <sub>RST</sub>	Time between release of reset source and code execution	_	50	_	μs
RST Low Time to Generate Reset	t <sub>RSTL</sub>		15	_	_	μs
Missing Clock Detector Response Time (final rising edge to reset)	t <sub>MCD</sub>	F <sub>SYSCLK</sub> >1 MHz	_	0.625	1.2	ms
Missing Clock Detector Trigger Frequency	F <sub>MCD</sub>		_	7.5	13.5	kHz
VDD Supply Monitor Turn-On Time	t <sub>MON</sub>		_	2	_	μs

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#### 4.1.4 Flash Memory

#### Table 4.4. Flash Memory

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Write Time <sup>1, 2</sup>	t <sub>WRITE</sub>	One Byte,	19	20	21	μs
		F <sub>SYSCLK</sub> = 24.5 MHz				
Erase Time <sup>1, 2</sup>	t <sub>ERASE</sub>	One Page,	5.2	5.35	5.5	ms
		F <sub>SYSCLK</sub> = 24.5 MHz				
V <sub>DD</sub> Voltage During Programming <sup>3</sup>	V <sub>PROG</sub>		2.2	_	3.6	V
Endurance (Write/Erase Cycles)	N <sub>WE</sub>		20k	100k	_	Cycles

#### Note:

- 1. Does not include sequencing time before and after the write/erase operation, which may be multiple SYSCLK cycles.
- 2. The internal High-Frequency Oscillator 0 has a programmable output frequency, which is factory programmed to 24.5 MHz. If user firmware adjusts the oscillator speed, it must be between 22 and 25 MHz during any flash write or erase operation. It is recommended to write the HFO0CAL register back to its reset value when writing or erasing flash.
- 3. Flash can be safely programmed at any voltage above the supply monitor threshold (V<sub>VDDM</sub>).
- 4. Data Retention Information is published in the Quarterly Quality and Reliability Report.

#### 4.1.5 Power Management Timing

**Table 4.5. Power Management Timing** 

Symbol	Test Condition	Min	Тур	Max	Units
t <sub>IDLEWK</sub>		2	_	3	SYSCLKs
t <sub>SUS-</sub> PENDWK	SYSCLK = HFOSC0 CLKDIV = 0x00	_	170	_	ns
tsleepwk	SYSCLK = HFOSC0	_	12	_	μs
	t <sub>IDLEWK</sub> t <sub>SUS-</sub> PENDWK	t <sub>IDLEWK</sub> t <sub>SUS-</sub> SYSCLK = HFOSC0  PENDWK CLKDIV = 0x00	t <sub>IDLEWK</sub> 2           t <sub>SUS-</sub> SYSCLK = HFOSC0         —           PENDWK         CLKDIV = 0x00         —           t <sub>SLEEPWK</sub> SYSCLK = HFOSC0         —	t <sub>IDLEWK</sub> 2         —           t <sub>SUS-</sub> SYSCLK = HFOSC0         —         170           PENDWK         CLKDIV = 0x00         —         12	t <sub>IDLEWK</sub> 2         —         3           t <sub>SUS-</sub> PENDWK         SYSCLK = HFOSC0         —         170         —           t <sub>SLEEPWK</sub> SYSCLK = HFOSC0         —         12         —

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#### 4.1.6 Internal Oscillators

#### **Table 4.6. Internal Oscillators**

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
High Frequency Oscillator 0 (24	4.5 MHz)					
Oscillator Frequency	f <sub>HFOSC0</sub>	Full Temperature and Supply Range	24	24.5	25	MHz
Power Supply Sensitivity	PSS <sub>HFOS</sub>	T <sub>A</sub> = 25 °C	_	0.5	_	%/V
Temperature Sensitivity	TS <sub>HFOSC0</sub>	V <sub>DD</sub> = 3.0 V	_	40	_	ppm/°C
High Frequency Oscillator 1 (4	8 MHz)		-1			
Oscillator Frequency	f <sub>HFOSC1</sub>	Full Temperature and Supply Range	47.3	48	48.7	MHz
Power Supply Sensitivity	PSS <sub>HFOS</sub>	T <sub>A</sub> = 25 °C	_	0.02	_	%/V
Temperature Sensitivity	TS <sub>HFOSC1</sub>	V <sub>DD</sub> = 3.0 V	_	45	_	ppm/°C
Low Frequency Oscillator (80 kg	(Hz)			1	1	
Oscillator Frequency	f <sub>LFOSC</sub>	Full Temperature and Supply Range	75	80	85	kHz
Power Supply Sensitivity	PSS <sub>LFOSC</sub>	T <sub>A</sub> = 25 °C	_	0.05	_	%/V
Temperature Sensitivity	TS <sub>LFOSC</sub>	V <sub>DD</sub> = 3.0 V	_	65	_	ppm/°C

#### 4.1.7 External Clock Input

Table 4.7. External Clock Input

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
External Input CMOS Clock	f <sub>CMOS</sub>		0	_	50	MHz
Frequency (at EXTCLK pin)						
External Input CMOS Clock High Time	t <sub>CMOSH</sub>		9	_	_	ns
External Input CMOS Clock Low Time	t <sub>CMOSL</sub>		9	_	_	ns



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4.1.8 ADC

#### Table 4.8. ADC

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Resolution	N <sub>bits</sub>	12 Bit Mode		12	1	Bits
		10 Bit Mode		10		Bits
Throughput Rate	f <sub>S</sub>	12 Bit Mode	_	_	200	ksps
(High Speed Mode)		10 Bit Mode	_	_	800	ksps
Throughput Rate	f <sub>S</sub>	12 Bit Mode	_	_	62.5	ksps
(Low Power Mode)		10 Bit Mode	_	_	250	ksps
Tracking Time	t <sub>TRK</sub>	High Speed Mode	230	_	_	ns
		Low Power Mode	450	_	_	ns
Power-On Time	t <sub>PWR</sub>		1.2	_	_	μs
SAR Clock Frequency	f <sub>SAR</sub>	High Speed Mode,	_	_	6.25	MHz
		Reference is 2.4 V internal				
		High Speed Mode,	_	_	12.5	MHz
		Reference is not 2.4 V internal				
		Low Power Mode	_	_	4	MHz
Conversion Time	t <sub>CNV</sub>	10-Bit Conversion,		1.1	1	μs
		SAR Clock = 12.25 MHz,				
		System Clock = 24.5 MHz.			5 —	
Sample/Hold Capacitor	C <sub>SAR</sub>	Gain = 1	_	5	_	pF
		Gain = 0.5	_	2.5	_	pF
Input Pin Capacitance	C <sub>IN</sub>		_	20	_	pF
Input Mux Impedance	R <sub>MUX</sub>		_	550	_	Ω
Voltage Reference Range	V <sub>REF</sub>		1	_	V <sub>IO</sub>	V
Input Voltage Range <sup>1</sup>	V <sub>IN</sub>	Gain = 1	0	_	V <sub>REF</sub>	V
		Gain = 0.5	0	_	2xV <sub>REF</sub>	V
Power Supply Rejection Ratio	PSRR <sub>ADC</sub>		_	70	_	dB
DC Performance						
Integral Nonlinearity	INL	12 Bit Mode	_	±1	±2.3	LSB
		10 Bit Mode	_	±0.2	±0.6	LSB
Differential Nonlinearity (Guaran-	DNL	12 Bit Mode	-1	±0.7	1.9	LSB
teed Monotonic)		10 Bit Mode	_	±0.2	±0.6	LSB
Offset Error	E <sub>OFF</sub>	12 Bit Mode, VREF = 1.65 V	-3	0	3	LSB
		10 Bit Mode, VREF = 1.65 V	-2	0	2	LSB
Offset Temperature Coefficient	TC <sub>OFF</sub>		_	0.004	_	LSB/°C



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Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Slope Error	E <sub>M</sub>	12 Bit Mode	_	±0.02	±0.1	%
		10 Bit Mode	_	±0.06	±0.24	%
Dynamic Performance 10 kHz Sine	Wave Input	1dB below full scale, Max throughput,	using AGNI	) pin		
Signal-to-Noise	SNR	12 Bit Mode	61	66	_	dB
		10 Bit Mode	53	60	_	dB
Signal-to-Noise Plus Distortion	SNDR	12 Bit Mode	61	66	_	dB
		10 Bit Mode	53	60	_	dB
Total Harmonic Distortion (Up to	THD	12 Bit Mode	_	71	_	dB
5th Harmonic)		10 Bit Mode	_	70	_	dB
Spurious-Free Dynamic Range	SFDR	12 Bit Mode	_	-79	_	dB
		10 Bit Mode	_	-70	_	dB

#### Note:

## 4.1.9 Voltage Reference

Table 4.9. Voltage Reference

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Internal Fast Settling Reference						
Output Voltage	V <sub>REFFS</sub>	1.65 V Setting	1.62	1.65	1.68	V
(Full Temperature and Supply Range)		2.4 V Setting, V <sub>DD</sub> > 2.6 V	2.35	2.4	2.45	V
Temperature Coefficient	TC <sub>REFFS</sub>		_	50	_	ppm/°C
Turn-on Time	t <sub>REFFS</sub>		_	_	1.5	μs
Power Supply Rejection	PSRR <sub>REF</sub> FS		_	400	_	ppm/V
External Reference						
Input Current	I <sub>EXTREF</sub>	Sample Rate = 800 ksps; VREF = 3.0 V	_	8	_	μА

<sup>1.</sup> Absolute input pin voltage is limited by the  $V_{DD}$  supply.

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#### 4.1.10 Temperature Sensor

Table 4.10. Temperature Sensor

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Offset	V <sub>OFF</sub>	T <sub>A</sub> = 0 °C	_	757	_	mV
Offset Error <sup>1</sup>	E <sub>OFF</sub>	T <sub>A</sub> = 0 °C	_	17	_	mV
Slope	М		_	2.85	_	mV/°C
Slope Error <sup>1</sup>	E <sub>M</sub>		_	70	_	μV/°
Linearity			_	0.5	_	°C
Turn-on Time			_	1.8	_	μs

#### Note:

#### 4.1.11 5 V Voltage Regulator

Table 4.11. 5V Voltage Regulator

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Input Voltage Range <sup>1</sup>	V <sub>REGIN</sub>		3.0	_	5.25	V
Output Voltage on VDD <sup>2</sup>	V <sub>REGOUT</sub>	Output Current = 1 to 100 mA	3.1	3.3	3.6	V
	Regulation range (VREGIN ≥ 4.1V)					
		Output Current = 1 to 100 mA	_	V <sub>REGIN</sub> –	_	V
	Dropout range (VREGIN			V <sub>DROPOUT</sub>		
Output Current <sup>2</sup>	I <sub>REGOUT</sub>		_	_	100	mA
Dropout Voltage	V <sub>DROPOUT</sub>	Output Current = 100 mA	_	_	0.8	V

#### Note

- Input range to meet the Output Voltage on VDD specification. If the 5 V voltage regulator is not used, VREGIN should be tied to VDD.
- 2. Output current is total regulator output, including any current required by the device.

<sup>1.</sup> Represents one standard deviation from the mean.

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## 4.1.12 Comparators

#### Table 4.12. Comparators

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Response Time, CPMD = 00	t <sub>RESP0</sub>	+100 mV Differential, V <sub>CM</sub> = 1.65 V	_	110	_	ns
(Highest Speed)		-100 mV Differential, V <sub>CM</sub> = 1.65 V	_	160	_	ns
Response Time, CPMD = 11 (Low-	t <sub>RESP3</sub>	+100 mV Differential, V <sub>CM</sub> = 1.65 V	_	1.2	_	μs
est Power)		-100 mV Differential, V <sub>CM</sub> = 1.65 V	_	4.5	_	μs
Positive Hysteresis	HYS <sub>CP+</sub>	CPHYP = 00	_	0.4	_	mV
Mode 0 (CPMD = 00)		CPHYP = 01	_	8	_	mV
		CPHYP = 10	_	16	_	mV
		CPHYP = 11	_	32	_	mV
Negative Hysteresis	HYS <sub>CP</sub> -	CPHYN = 00	_	-0.4	_	mV
Mode 0 (CPMD = 00)		CPHYN = 01	_	-8	_	mV
		CPHYN = 10	_	-16	_	mV
		CPHYN = 11	_	-32	_	mV
Positive Hysteresis	HYS <sub>CP+</sub>	CPHYP = 00	_	1.5	_	mV
Mode 3 (CPMD = 11)		CPHYP = 01	_	4	_	mV
		CPHYP = 10	_	8	_	mV
		CPHYP = 11	_	16	_	mV
Negative Hysteresis	HYS <sub>CP</sub> -	CPHYN = 00	_	-1.5	_	mV
Mode 3 (CPMD = 11)		CPHYN = 01	_	-4	_	mV
		CPHYN = 10	_	-8	_	mV
		CPHYN = 11	_	-16	_	mV
Input Range (CP+ or CP-)	V <sub>IN</sub>	Direct comparator input	-0.25	_	V <sub>IO</sub> +0.25	V
		Reference DAC input	1.2		V <sub>IO</sub>	V
Reference DAC Resolution	N <sub>bits</sub>			6		bits
Reference DAC Input Impedance	R <sub>CPREF</sub>		_	2.75	_	МΩ
Input Pin Capacitance	C <sub>CP</sub>		_	7.5	_	pF
Common-Mode Rejection Ratio	CMRR <sub>CP</sub>		_	70	_	dB
Power Supply Rejection Ratio	PSRR <sub>CP</sub>		_	72	_	dB
Input Offset Voltage	V <sub>OFF</sub>	T <sub>A</sub> = 25 °C	-10	0	10	mV
Input Offset Tempco	TC <sub>OFF</sub>		_	3.5	_	μV/°

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#### 4.1.13 Port I/O

#### Table 4.13. Port I/O

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Output High Voltage (High Drive)	V <sub>OH</sub>	I <sub>OH</sub> = -7 mA, V <sub>IO</sub> ≥ 3.0 V	V <sub>IO</sub> - 0.7	_	_	V
		I <sub>OH</sub> = -3.3 mA, 2.2 V ≤ V <sub>IO</sub> < 3.0 V	V <sub>IO</sub> x 0.8	_	_	V
		$I_{OH}$ = -1.8 mA, 1.71 V $\leq$ V <sub>IO</sub> $<$ 2.2 V				
Output Low Voltage (High Drive)	V <sub>OL</sub>	I <sub>OL</sub> = 13.5 mA, V <sub>IO</sub> ≥ 3.0 V	_	_	0.6	V
		I <sub>OL</sub> = 7 mA, 2.2 V ≤ V <sub>IO</sub> < 3.0 V	_	_	V <sub>IO</sub> x 0.2	V
		$I_{OL}$ = 3.6 mA, 1.71 V $\leq$ V <sub>IO</sub> $<$ 2.2 V				
Output High Voltage (Low Drive)	V <sub>OH</sub>	$I_{OH}$ = -4.75 mA, $V_{IO} \ge 3.0 \text{ V}$	V <sub>IO</sub> - 0.7	_	_	V
		$I_{OH}$ = -2.25 mA, 2.2 V $\leq$ V <sub>IO</sub> $<$ 3.0 V	V <sub>IO</sub> x 0.8	_	_	V
		$I_{OH}$ = -1.2 mA, 1.71 V $\leq$ V <sub>IO</sub> $<$ 2.2 V				
Output Low Voltage (Low Drive)	V <sub>OL</sub>	$I_{OL}$ = 6.5 mA, $V_{IO} \ge 3.0 \text{ V}$	_	_	0.6	V
		$I_{OL}$ = 3.5 mA, 2.2 V $\leq$ V <sub>IO</sub> $<$ 3.0 V	_	_	V <sub>IO</sub> x 0.2	V
		$I_{OL}$ = 1.8 mA, 1.71 V $\leq$ V <sub>IO</sub> $<$ 2.2 V				
Input High Voltage	V <sub>IH</sub>		V <sub>IO</sub> - 0.6	_	_	V
(all port pins including VBUS)						
Input Low Voltage	V <sub>IL</sub>		_	_	0.6	V
(all port pins including VBUS)						
Pin Capacitance	C <sub>IO</sub>		_	7	_	pF
Weak Pull-Up Current	I <sub>PU</sub>	V <sub>DD</sub> = 3.6	-30	-20	-10	μΑ
(V <sub>IN</sub> = 0 V)						
Input Leakage (Pullups off or Analog)	I <sub>LK</sub>	GND < V <sub>IN</sub> < V <sub>IO</sub>	-1.1	_	1.1	μΑ
Input Leakage Current with V <sub>IN</sub> above V <sub>IO</sub>	I <sub>LK</sub>	V <sub>IO</sub> < V <sub>IN</sub> < V <sub>IO</sub> +2.0 V	0	5	150	μΑ

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#### 4.1.14 USB Transceiver

#### Table 4.14. USB Transceiver

Symbol	Test Condition	Min	Тур	Max	Unit
<u>'</u>		'			
V <sub>OH</sub>	V <sub>DD</sub> ≥3.0V	2.8	_	_	V
V <sub>OL</sub>	V <sub>DD</sub> ≥3.0V	_	_	0.8	V
V <sub>CRS</sub>		1.3	_	2.0	V
Z <sub>DRV</sub>	Driving High	28	36	44	Ω
	Driving Low	28	36	44	
R <sub>PU</sub>	Full Speed (D+ Pull-up)	1.425	1.5	1.575	kΩ
	Low Speed (D- Pull-up)				
T <sub>R</sub>	Low Speed	75	_	300	ns
	Full Speed	4	_	20	ns
T <sub>F</sub>	Low Speed	75	_	300	ns
	Full Speed	4	_	20	ns
V <sub>DI</sub>	(D+) - (D-)	0.2	_	_	V
V <sub>CM</sub>		0.8	_	2.5	V
IL	Pullups Disabled	_	<1.0	_	μA
	Voh Vol Vcrs ZDRV  RPU  T <sub>R</sub> VDI  VCM	$ V_{OH} \qquad V_{DD} \ge 3.0 V $ $ V_{OL} \qquad V_{DD} \ge 3.0 V $ $ V_{CRS} \qquad                                   $	VOH       VDD ≥3.0V       2.8         VOL       VDD ≥3.0V       —         VCRS       1.3         ZDRV       Driving High       28         Driving Low       28         RPU       Full Speed (D+ Pull-up)       1.425         Low Speed (D- Pull-up)       75         Full Speed       4         TF       Low Speed       75         Full Speed       4         VDI         (D+) - (D-)         0.2         VCM       0.8	VOH       VDD ≥3.0V       2.8       —         VOL       VDD ≥3.0V       —       —         VCRS       1.3       —         ZDRV       Driving High       28       36         Driving Low       28       36         RPU       Full Speed (D+ Pull-up)       1.425       1.5         Low Speed (D- Pull-up)       75       —         Full Speed       4       —         TF       Low Speed       75       —         Full Speed       4       —         VDI       I (D+) - (D-) I       0.2       —         VCM       0.8       —	VOH       VDD ≥3.0V       2.8       —       —         VOL       VDD ≥3.0V       —       —       0.8         VCRS       1.3       —       2.0         ZDRV       Driving High       28       36       44         Driving Low       28       36       44         RPU       Full Speed (D+ Pull-up)       1.425       1.5       1.575         Low Speed (D- Pull-up)       75       —       300         Full Speed       4       —       20         TF       Low Speed       75       —       300         Full Speed       4       —       20         VDI       I (D+) - (D-) I       0.2       —       —         VCM       0.8       —       2.5

#### 4.2 Thermal Conditions

**Table 4.15. Thermal Conditions** 

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit
Thermal Resistance	$\theta_{JA}$	QFN-20 Packages – 60		60	_	°C/W
		QFN-28 Packages	_	26	_	°C/W
		QSOP-24 Packages	_	65	_	°C/W

#### Note:

1. Thermal resistance assumes a multi-layer PCB with any exposed pad soldered to a PCB pad.



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#### 4.3 Absolute Maximum Ratings

Stresses above those listed in 4.3 Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the devices at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability. For more information on the available quality and reliability data, see the Quality and Reliability Monitor Report at http://www.silabs.com/support/quality/pages/default.aspx.

Table 4.16. Absolute Maximum Ratings

Parameter	Symbol	Test Condition	Min	Max	Unit
Ambient Temperature Under Bias	T <sub>BIAS</sub>		-55	125	°C
Storage Temperature	T <sub>STG</sub>		-65	150	°C
Voltage on VDD	V <sub>DD</sub>		GND-0.3	4.2	V
Voltage on VIO <sup>2</sup>	V <sub>IO</sub>		GND-0.3	4.2	V
Voltage on VREGIN	V <sub>REGIN</sub>		GND-0.3	5.8	V
Voltage on D+ or D-	V <sub>USBD</sub>		GND-0.3	V <sub>DD</sub> +0.3	V
Voltage on I/O pins (including VBUS /	V <sub>IN</sub>	V <sub>IO</sub> > 3.3 V	GND-0.3	5.8	V
P3.1) or RSTb		V <sub>IO</sub> < 3.3 V	GND-0.3	V <sub>IO</sub> +2.5	V
Total Current Sunk into Supply Pin	I <sub>VDD</sub>		_	400	mA
Total Current Sourced out of Ground Pin	I <sub>GND</sub>		400	_	mA
Current Sourced or Sunk by any I/O Pin or RSTb	I <sub>IO</sub>		-100	100	mA
Operating Junction Temperature	TJ		-40	105	°C

#### Note:

- 1. Exposure to maximum rating conditions for extended periods may affect device reliability.
- 2. On devices without a VIO pin,  $V_{IO} = V_{DD}$

## 4.4 Typical Performance Curves

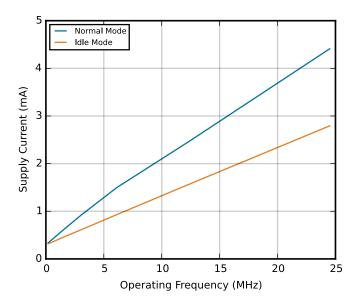


Figure 4.1. Typical Operating Supply Current using HFOSC0

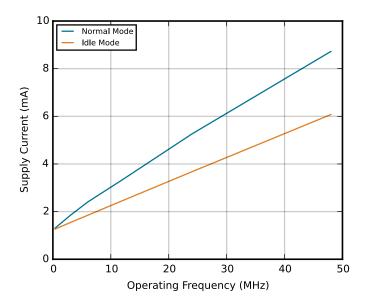


Figure 4.2. Typical Operating Supply Current using HFOSC1

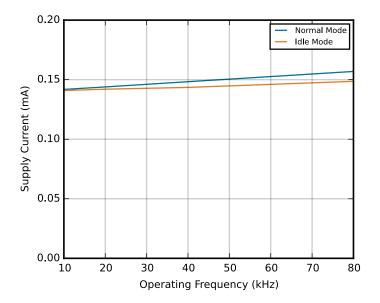


Figure 4.3. Typical Operating Supply Current using LFOSC

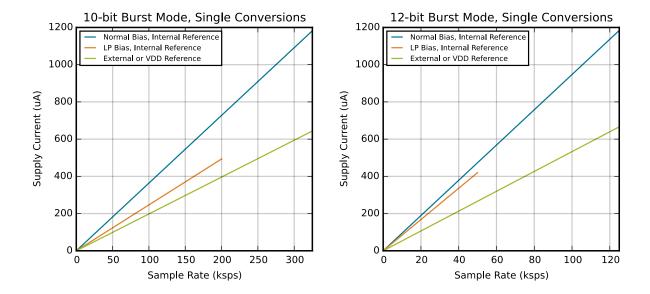


Figure 4.4. Typical ADC0 and Internal Reference Supply Current in Burst Mode

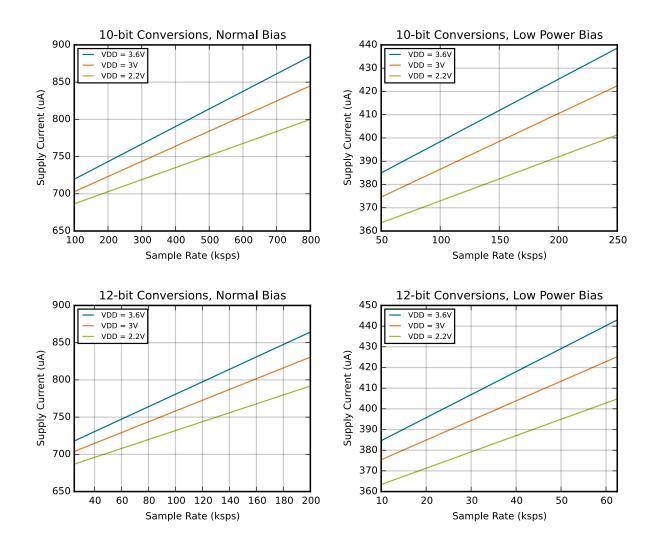


Figure 4.5. Typical ADC0 Supply Current in Normal (always-on) Mode

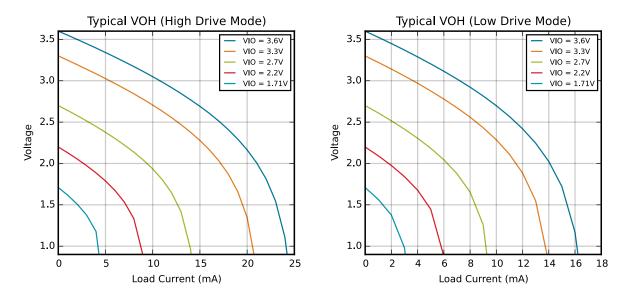


Figure 4.6. Typical V<sub>OH</sub> Curves

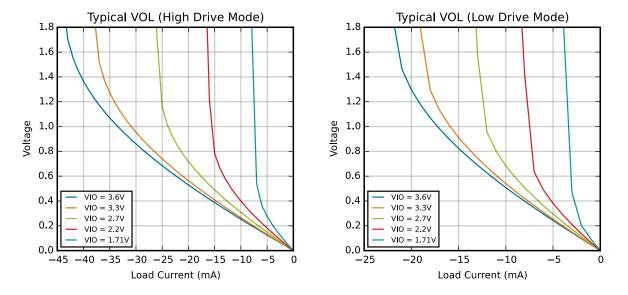


Figure 4.7. Typical V<sub>OL</sub> Curves

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**Typical Connection Diagrams** 

## 5. Typical Connection Diagrams

#### 5.1 Power

The figure below shows a typical connection diagram for the power pins of the EFM8UB1 devices when the internal regulator used and USB is connected (bus-powered). VBUS is not used as a sense pin in this scenario, so that pin can be used as a standard GPIO.

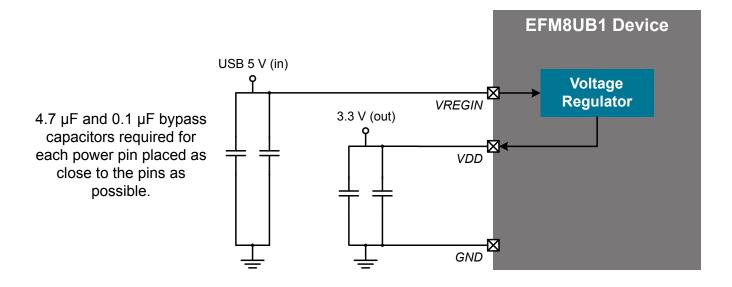


Figure 5.1. Connection Diagram with Voltage Regulator Used and USB Connected (Bus-Powered)

The figure below shows a typical connection diagram for the power pins of the EFM8UB1 devices when the internal regulator used and USB is connected (self-powered). The VBUS signal is used to detect when USB is connected to a host device.

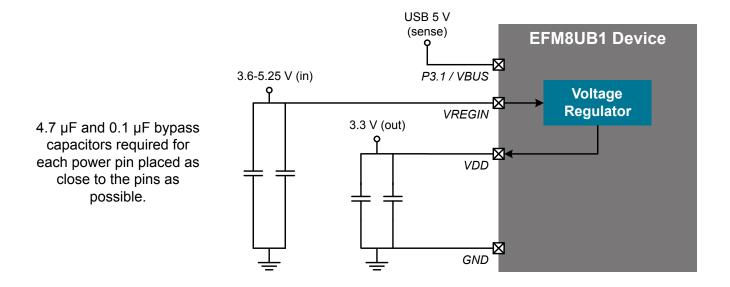


Figure 5.2. Connection Diagram with Voltage Regulator Used and USB Connected (Self-Powered)

The figure below shows a typical connection diagram for the power pins of the EFM8UB1 devices when the internal 5 V-to-3.3 V regulator is not used.

**Typical Connection Diagrams** 

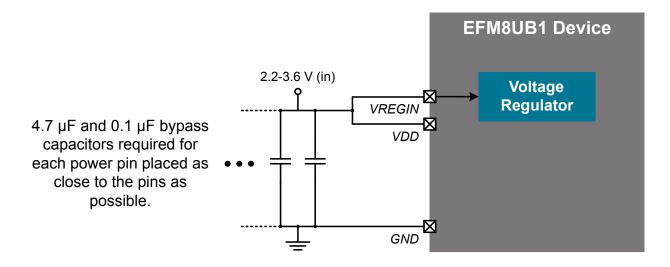


Figure 5.3. Connection Diagram with Voltage Regulator Not Used

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Typical Connection Diagrams

#### 5.2 USB

Figure 5.4 Bus-Powered Connection Diagram for USB Pins on page 31 shows a typical connection bus-powered diagram for the USB pins of the EFM8UB1 devices including ESD protection diodes on the USB pins.

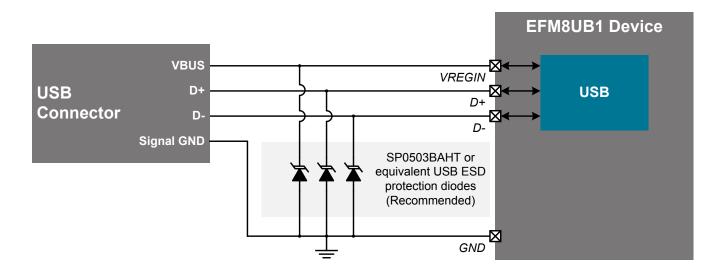


Figure 5.4. Bus-Powered Connection Diagram for USB Pins

Figure 5.5 Self-Powered Connection Diagram for USB Pins on page 31 shows a typical connection self-powered diagram for the USB pins of the EFM8UB1 devices including ESD protection diodes on the USB pins.

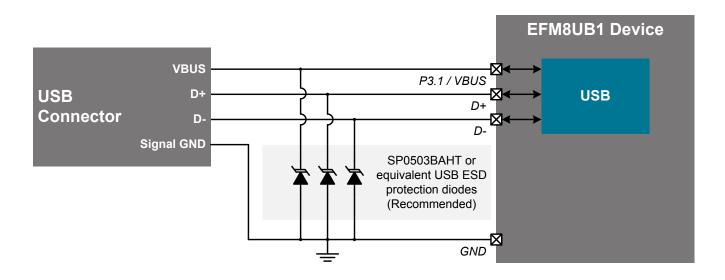


Figure 5.5. Self-Powered Connection Diagram for USB Pins



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**Typical Connection Diagrams** 

#### 5.3 Debug

The diagram below shows a typical connection diagram for the debug connections pins. The pin sharing resistors are only required if the functionality on the C2D (a GPIO pin) and the C2CK (RSTb) is routed to external circuitry. For example, if the RSTb pin is connected to an external switch with debouncing filter or if the GPIO sharing with the C2D pin is connected to an external circuit, the pin sharing resistors and connections to the debug adapter must be placed on the hardware. Otherwise, these components and connections can be omitted.

For more information on debug connections, see the example schematics and information available in AN127: "Pin Sharing Techniques for the C2 Interface." Application notes can be found on the Silicon Labs website (http://www.silabs.com/8bit-appnotes) or in Simplicity Studio.

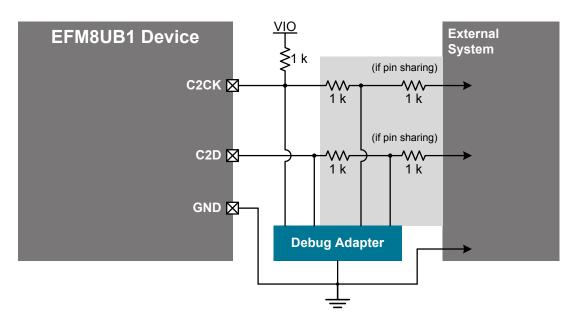


Figure 5.6. Debug Connection Diagram

#### 5.4 Other Connections

Other components or connections may be required to meet the system-level requirements. Application Note AN203: "8-bit MCU Printed Circuit Board Design Notes" contains detailed information on these connections. Application Notes can be accessed on the Silicon Labs website (www.silabs.com/8bit-appnotes).

## 6. Pin Definitions

## 6.1 EFM8UB1x-QFN28 Pin Definitions

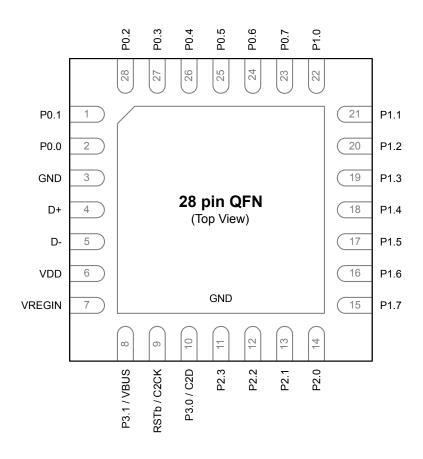


Figure 6.1. EFM8UB1x-QFN28 Pinout

Table 6.1. Pin Definitions for EFM8UB1x-QFN28

Pin Number	Pin Name	Description	Crossbar Capability	Additional Digital Functions	Analog Functions
1	P0.1	Multifunction I/O	Yes	P0MAT.1	ADC0.1
				INT0.1	CMP0P.1
				INT1.1	CMP0N.1
					AGND



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Pin Definitions

Pin	Pin Name	Description	Crossbar Capability	Additional Digital	Analog Functions
Number				Functions	
2	P0.0	Multifunction I/O	Yes	P0MAT.0	ADC0.0
				INT0.0	CMP0P.0
				INT1.0	CMP0N.0
					VREF
3	GND	Ground			
4	D+	USB Data Positive			ADC0.28
5	D-	USB Data Negative			ADC0.29
6	VDD	Supply Power Input /			
		5V Regulator Output			
7	VREGIN	5V Regulator Input			
8	P3.1	Multifunction I/O		VBUS	
9	RST /	Active-low Reset /			
	C2CK	C2 Debug Clock			
10	P3.0 /	Multifunction I/O /			
	C2D	C2 Debug Data			
11	P2.3	Multifunction I/O	Yes	P2MAT.3	ADC0.23
					CMP1P.12
					CMP1N.12
12	P2.2	Multifunction I/O	Yes	P2MAT.2	ADC0.22
					CMP1P.11
					CMP1N.11
13	P2.1	Multifunction I/O	Yes	P2MAT.1	ADC0.21
					CMP1P.10
					CMP1N.10
14	P2.0	Multifunction I/O	Yes	P2MAT.0	ADC0.20
					CMP1P.9
					CMP1N.9
15	P1.7	Multifunction I/O	Yes	P1MAT.7	ADC0.15
					CMP1P.7
					CMP1N.7
16	P1.6	Multifunction I/O	Yes	P1MAT.6	ADC0.14
				I2C0_SCL	CMP1P.6
					CMP1N.6
17	P1.5	Multifunction I/O	Yes	P1MAT.5	ADC0.13
				I2C0_SDA	CMP1P.5
					CMP1N.5



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Pin Number	Pin Name	Description	Crossbar Capability	Additional Digital Functions	Analog Functions
18	P1.4	Multifunction I/O	Yes	P1MAT.4	ADC0.12
					CMP1P.4
					CMP1N.4
19	P1.3	Multifunction I/O	Yes	P1MAT.3	ADC0.11
					CMP1P.3
					CMP1N.3
20	P1.2	Multifunction I/O	Yes	P1MAT.2	ADC0.10
					CMP1P.2
					CMP1N.2
21	P1.1	Multifunction I/O	Yes	P1MAT.1	ADC0.9
					CMP1P.1
					CMP1N.1
					CMP0P.10
					CMP0N.10
22	P1.0	Multifunction I/O	Yes	P1MAT.0	ADC0.8
					CMP1P.0
					CMP1N.0
					CMP0P.9
					CMP0N.9
23	P0.7	Multifunction I/O	Yes	P0MAT.7	ADC0.7
				INT0.7	CMP0P.7
				INT1.7	CMP0N.7
24	P0.6	Multifunction I/O	Yes	P0MAT.6	ADC0.6
				CNVSTR	CMP0P.6
				INT0.6	CMP0N.6
				INT1.6	
25	P0.5	Multifunction I/O	Yes	P0MAT.5	ADC0.5
				INT0.5	CMP0P.5
				INT1.5	CMP0N.5
				UART0_RX	
26	P0.4	Multifunction I/O	Yes	P0MAT.4	ADC0.4
				INT0.4	CMP0P.4
				INT1.4	CMP0N.4
				UART0_TX	



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Pin Number	Pin Name	Description	Crossbar Capability	Additional Digital Functions	Analog Functions
27	P0.3	Multifunction I/O	Yes	P0MAT.3	ADC0.3
				EXTCLK	CMP0P.3
				INT0.3	CMP0N.3
				INT1.3	
28	P0.2	Multifunction I/O	Yes	P0MAT.2	ADC0.2
				INT0.2	CMP0P.2
				INT1.2	CMP0N.2
Center	GND	Ground			

#### 6.2 EFM8UB1x-QSOP24 Pin Definitions

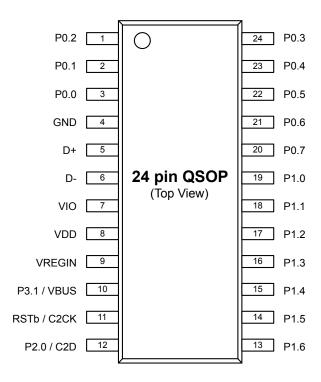


Figure 6.2. EFM8UB1x-QSOP24 Pinout

Table 6.2. Pin Definitions for EFM8UB1x-QSOP24

Pin Number	Pin Name	Description	Crossbar Capability	Additional Digital Functions	Analog Functions
1	P0.2	Multifunction I/O	Yes	P0MAT.2	ADC0.2
				INT0.2	CMP0P.2
				INT1.2	CMP0N.2
2	P0.1	Multifunction I/O	Yes	P0MAT.1	ADC0.1
				INT0.1	CMP0P.1
				INT1.1	CMP0N.1
					AGND



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Pin	Pin Name	Description	Crossbar Capability	Additional Digital	Analog Functions
Number				Functions	
3	P0.0	Multifunction I/O	Yes	P0MAT.0	ADC0.0
				INT0.0	CMP0P.0
				INT1.0	CMP0N.0
					VREF
4	GND	Ground			
5	D+	USB Data Positive			ADC0.28
6	D-	USB Data Negative			ADC0.29
7	VIO	I/O Power Input			
8	VDD	Supply Power Input /			
		5V Regulator Output			
9	VREGIN	5V Regulator Input			
10	P3.1	Multifunction I/O		VBUS	
11	RSTb /	Active-low Reset /			
	C2CK	C2 Debug Clock			
12	P2.0 /	Multifunction I/O /	Yes		
	C2D	C2 Debug Data			
13	P1.6	Multifunction I/O	Yes	P1MAT.6	ADC0.14
					CMP1P.9
					CMP1N.9
14	P1.5	Multifunction I/O	Yes	P1MAT.5	ADC0.13
					CMP1P.7
					CMP1N.7
15	P1.4	Multifunction I/O	Yes	P1MAT.4	ADC0.12
					CMP1P.6
					CMP1N.6
16	P1.3	Multifunction I/O	Yes	P1MAT.3	ADC0.11
					CMP1P.5
					CMP1N.5
17	P1.2	Multifunction I/O	Yes	P1MAT.2	ADC0.10
				12C0_SCL	CMP1P.4
					CMP1N.4
18	P1.1	Multifunction I/O	Yes	P1MAT.1	ADC0.9
				I2C0_SDA	CMP1P.3
					CMP1N.3



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Pin Number	Pin Name	Description	Crossbar Capability	Additional Digital Functions	Analog Functions
19	P1.0	Multifunction I/O	Yes	P1MAT.0	ADC0.8
					CMP1P.2
					CMP1N.2
20	P0.7	Multifunction I/O	Yes	P0MAT.7	ADC0.7
				INT0.7	CMP1P.1
				INT1.7	CMP1N.1
					CMP0P.7
					CMP0N.7
21	P0.6	Multifunction I/O	Yes	P0MAT.6	ADC0.6
				CNVSTR	CMP1P.0
				INT0.6	CMP1N.0
				INT1.6	CMP0P.6
					CMP0N.6
22	P0.5	Multifunction I/O	Yes	P0MAT.5	ADC0.5
				INT0.5	CMP0P.5
				INT1.5	CMP0N.5
				UART0_RX	
23	P0.4	Multifunction I/O	Yes	P0MAT.4	ADC0.4
				INT0.4	CMP0P.4
				INT1.4	CMP0N.4
				UART0_TX	
24	P0.3	Multifunction I/O	Yes	P0MAT.3	ADC0.3
				EXTCLK	CMP0P.3
				INT0.3	CMP0N.3
				INT1.3	

#### 6.3 EFM8UB1x-QFN20 Pin Definitions

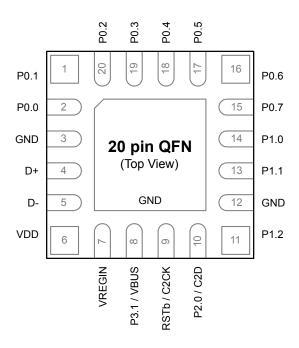


Figure 6.3. EFM8UB1x-QFN20 Pinout

Table 6.3. Pin Definitions for EFM8UB1x-QFN20

Pin Number	Pin Name	Description	Crossbar Capability	Additional Digital Functions	Analog Functions
1	P0.1	Multifunction I/O	Yes	P0MAT.1	ADC0.1
				INT0.1	CMP0P.1
				INT1.1	CMP0N.1
					AGND
2	P0.0	Multifunction I/O	Yes	P0MAT.0	ADC0.0
				INT0.0	CMP0P.0
				INT1.0	CMP0N.0
					VREF



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Pin	Pin Name	Description	Crossbar Capability	Additional Digital	Analog Functions
Number				Functions	
3	GND	Ground			
4	D+	USB Data Positive			ADC0.28
5	D-	USB Data Negative			ADC0.29
6	VDD	Supply Power Input /			
		5V Regulator Output			
7	VREGIN	5V Regulator Input			
8	P3.1	Multifunction I/O		VBUS	
9	RST /	Active-low Reset /			
	C2CK	C2 Debug Clock			
10	P2.0 /	Multifunction I/O /	Yes		
	C2D	C2 Debug Data			
11	P1.2	Multifunction I/O	Yes	P1MAT.2	ADC0.10
				I2C0_SCL	CMP1P.4
					CMP1N.4
12	GND	Ground			
13	P1.1	Multifunction I/O	Yes	P1MAT.1	ADC0.9
				I2C0_SDA	CMP1P.3
					CMP1N.3
14	P1.0	Multifunction I/O	Yes	P1MAT.0	ADC0.8
					CMP1P.2
					CMP1N.2
15	P0.7	Multifunction I/O	Yes	P0MAT.7	ADC0.7
				INT0.7	CMP1P.1
				INT1.7	CMP1N.1
					CMP0P.7
					CMP0N.7
16	P0.6	Multifunction I/O	Yes	P0MAT.6	ADC0.6
				CNVSTR	CMP1P.0
				INT0.6	CMP1N.0
				INT1.6	CMP0P.6
					CMP0N.6
17	P0.5	Multifunction I/O	Yes	P0MAT.5	ADC0.5
				INT0.5	CMP0P.5
				INT1.5	CMP0N.5
				UART0_RX	



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Pin Definitions

Pin Number	Pin Name	Description	Crossbar Capability	Additional Digital Functions	Analog Functions
18	P0.4	Multifunction I/O	Yes	P0MAT.4	ADC0.4
				INT0.4	CMP0P.4
				INT1.4	CMP0N.4
				UART0_TX	
19	P0.3	Multifunction I/O	Yes	P0MAT.3	ADC0.3
				EXTCLK	CMP0P.3
				INT0.3	CMP0N.3
				INT1.3	
20	P0.2	Multifunction I/O	Yes	P0MAT.2	ADC0.2
				INT0.2	CMP0P.2
				INT1.2	CMP0N.2
Center	GND	Ground			

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**QFN28 Package Specifications** 

### 7. QFN28 Package Specifications

#### 7.1 QFN28 Package Dimensions

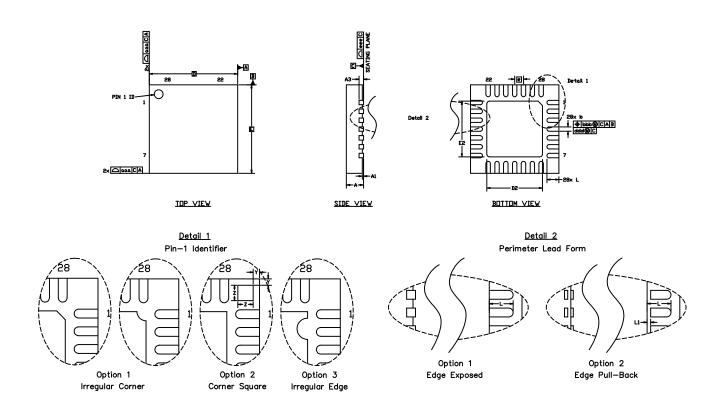


Figure 7.1. QFN28 Package Drawing

Table 7.1. QFN28 Package Dimensions

Dimension	Min	Тур	Max	
Α	0.70	0.75	0.80	
A1	0.00	_	0.05	
A3		0.20 REF		
b	0.20	0.25	0.30	
D	4.90	5.00	5.10	
D2	3.15	3.25	3.35	
е	0.50 BSC			
Е	4.90	5.00	5.10	
E2	3.15	3.25	3.35	
L	0.45	0.55	0.65	
aaa	0.15			
bbb	0.10			
ddd		0.05		



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QFN28 Package Specifications

Dimension	Min	Тур	Max
eee		0.08	

#### Note:

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
- 3. This drawing conforms to JEDEC Solid State Outline MO-220.
- 4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

#### 7.2 QFN28 PCB Land Pattern

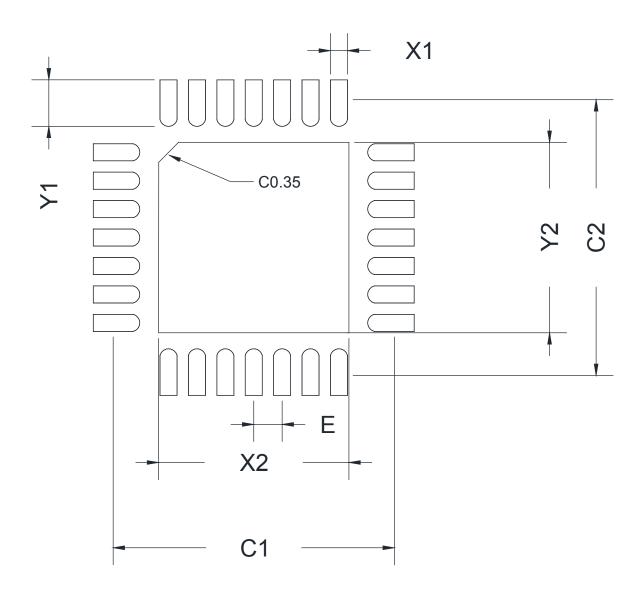


Figure 7.2. QFN28 PCB Land Pattern Drawing

Table 7.2. QFN28 PCB Land Pattern Dimensions

Dimension	Min	Max
C1	4.8	30
C2	4.8	30
Е	0.5	50
X1	0.3	30
X2	3.3	35
Y1	9.0	95



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QFN28 Package Specifications

Dimension	Min	Max
Y2	3.35	

#### Note:

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. This Land Pattern Design is based on the IPC-7351 guidelines.
- 3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60 μm minimum, all the way around the pad.
- 4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 5. The stencil thickness should be 0.125 mm (5 mils).
- 6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
- 7. A 2 x 2 array of 1.2 mm square openings on a 1.5 mm pitch should be used for the center pad.
- 8. A No-Clean, Type-3 solder paste is recommended.
- 9. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

#### 7.3 QFN28 Package Marking

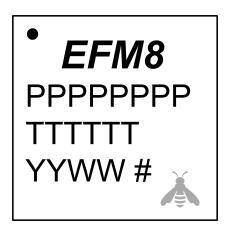


Figure 7.3. QFN28 Package Marking

The package marking consists of:

- PPPPPPP The part number designation.
- TTTTTT A trace or manufacturing code.
- YY The last 2 digits of the assembly year.
- WW The 2-digit workweek when the device was assembled.
- # The device revision (A, B, etc.).

### 8. QSOP24 Package Specifications

#### 8.1 QSOP24 Package Dimensions

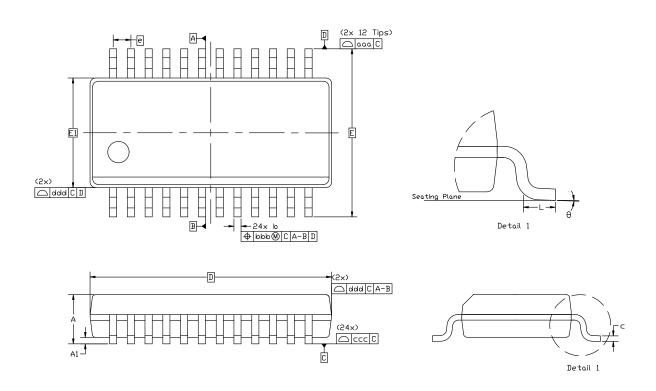


Figure 8.1. QSOP24 Package Drawing

Table 8.1. QSOP24 Package Dimensions

Dimension	Min	Тур	Max									
A	_	_	1.75									
A1	0.10	_	0.25									
b	0.20	_	0.30									
С	0.10	_	0.25									
D	8.65 BSC											
Е		6.00 BSC										
E1		3.90 BSC										
е		0.635 BSC										
L	0.40	_	1.27									
theta	0°	_	8°									



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Dimension	Min	Тур	Max
aaa		0.20	
bbb		0.18	
ccc		0.10	
ddd		0.10	

#### Note:

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
- 3. This drawing conforms to JEDEC outline MO-137, variation AE.
- 4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

#### 8.2 QSOP24 PCB Land Pattern

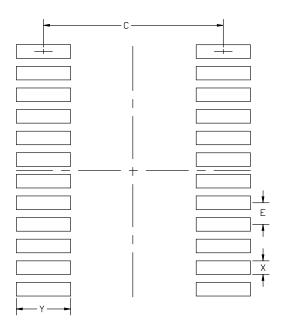


Figure 8.2. QSOP24 PCB Land Pattern Drawing

Table 8.2. QSOP24 PCB Land Pattern Dimensions

Dimension	Min	Max									
С	5.20	5.30									
Е	0.635 BSC										
Х	0.30	0.40									
Y	1.50	1.60									

#### Note

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. This land pattern design is based on the IPC-7351 guidelines.
- 3. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be  $60 \mu m$  minimum, all the way around the pad.
- 4. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 5. The stencil thickness should be 0.125 mm (5 mils).
- 6. The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pads.
- 7. A No-Clean, Type-3 solder paste is recommended.
- 8. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

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**QSOP24 Package Specifications** 

#### 8.3 QSOP24 Package Marking



Figure 8.3. QSOP24 Package Marking

The package marking consists of:

- PPPPPPP The part number designation.
- TTTTTT A trace or manufacturing code.
- YY The last 2 digits of the assembly year.
- WW The 2-digit workweek when the device was assembled.
- # The device revision (A, B, etc.).

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### 9. QFN20 Package Specifications

#### 9.1 QFN20 Package Dimensions

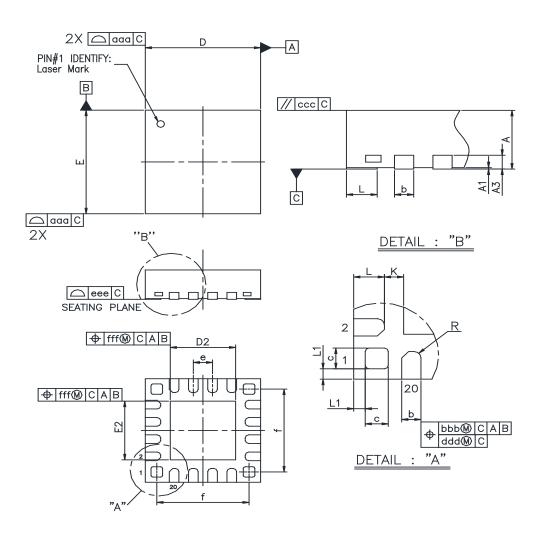


Figure 9.1. QFN20 Package Drawing

Table 9.1. QFN20 Package Dimensions

Dimension	Min	Тур	Max								
A	0.70	0.75	0.80								
A1	0.00	0.02	0.05								
A3	0.20 REF										
b	0.18	0.25	0.30								
С	0.25	0.30	0.35								
D		3.00 BSC									
D2	1.6	1.70	1.80								
е	0.50 BSC										



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QFN20 Package Specifications

0.10

Dimension Min Тур Max Ε 3.00 BSC E2 1.60 1.70 1.80 f 2.50 BSC L 0.30 0.40 0.50 K 0.25 REF R 0.09 0.125 0.15 aaa 0.15 bbb 0.10 0.10 CCC ddd 0.05 0.08

#### Note:

eee

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
- 3. The drawing complies with JEDEC MO-220.
- 4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

#### 9.2 QFN20 PCB Land Pattern

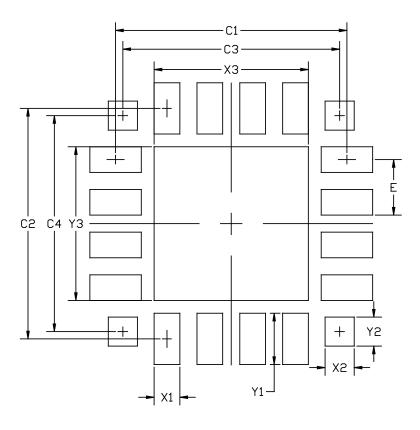


Figure 9.2. QFN20 PCB Land Pattern Drawing

Table 9.2. QFN20 PCB Land Pattern Dimensions

Dimension	Min	Max								
C1	3.10	)								
C2	3.10	)								
C3	2.50	)								
C4	2.50	)								
Е	0.50									
X1	0.30	)								
X2	0.25	0.35								
Х3	1.80	)								
Y1	0.90	)								
Y2	0.25	0.35								
Y3	1.80	)								



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QFN20 Package Specifications

Dimension Min Max

#### Note:

- 1. All dimensions shown are in millimeters (mm) unless otherwise noted.
- 2. Dimensioning and Tolerancing is per the ANSI Y14.5M-1994 specification.
- 3. This Land Pattern Design is based on the IPC-7351 guidelines.
- 4. All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be  $60 \mu m$  minimum, all the way around the pad.
- 5. A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- 6. The stencil thickness should be 0.125 mm (5 mils).
- 7. The ratio of stencil aperture to land pad size should be 1:1 for the perimeter pads.
- 8. A 2 x 2 array of 0.75 mm openings on a 0.95 mm pitch should be used for the center pad to assure proper paste volume.
- 9. A No-Clean, Type-3 solder paste is recommended.
- 10. The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

#### 9.3 QFN20 Package Marking

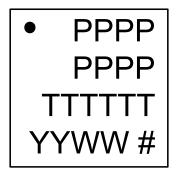


Figure 9.3. QFN20 Package Marking

The package marking consists of:

- PPPPPPP The part number designation.
- TTTTTT A trace or manufacturing code.
- YY The last 2 digits of the assembly year.
- WW The 2-digit workweek when the device was assembled.
- # The device revision (A, B, etc.).



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Revision History

### 10. Revision History

#### 10.1 Revision 1.1

December 16, 2015

Updated 3.2 Power to properly reflect that a comparator falling edge wakes the device from Suspend and Snooze.

Added Note 4 to Table 4.1 Recommended Operating Conditions on page 12.

Added 5.3 Debug.

#### 10.2 Revision 1.0

Updated any TBD numbers in 4.1 Electrical Characteristics and adjusted various specifications.

Updated VOH and VOL graphs in Figure 4.6 Typical V<sub>OH</sub> Curves on page 28 and Figure 4.7 Typical V<sub>OL</sub> Curves on page 28 and updated the VOH and VOL specifications in Table 4.13 Port I/O on page 22.

Added more information to 3.10 Bootloader.

Updated part numbers to Revision C.

#### 10.3 Revision 0.3

Updated QFN20 packaging and landing diagram dimensions.

Updated QFN28 D and E minimum value.

Updated some characterization TBD values.

Added maximum allowable voltages on D+ and D- and added VBUS / P3.1 to the standard I/O row in Table 4.16 Absolute Maximum Ratings on page 24.

Added a diagram to 5.1 Power for cases when the internal 5 V-to-3.3 V regulator is not used.

Updated the 5 V-to-3.3 V regulator Electrical Characteristics table.

Added Stop mode to the Power Modes table in 3.2 Power.

#### 10.4 Revision 0.2

Initial release.



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